

Product Summary (@T_A = +25°C)

V _{BR} (MIN)	I _{PP} (MAX)	V _C (MAX)
14.4V	10.5A	21.5V

Description

This new generation TVS is designed for transient overvoltage protection. The combination of small size and high ESD surge capability makes it ideal for use in power management and battery contact.

Applications

It is ideally suited for use in applications such as the following:

- Power Management
- Automotive
- Battery Contacts

Features

- 225W Peak Pulse Power Dissipation (10µs × 1000µs Waveform)
- 13V Standoff Voltage
- Provides ESD Protection per IEC 61000-4-2 Standard:
Air ±30kV, Contact ±30kV
- Excellent Clamping Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Matte Tin Finish Annealed over Copper Alloy Leadframe. Solderable per MIL-STD-202, Method 208 Ⓔ3
- Weight: 0.018 grams (Approximate)

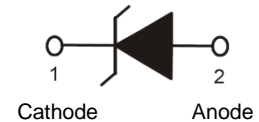
SOD123F (Type B)



Top View

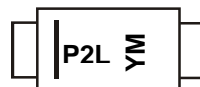


Bottom View


Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size(inches)	Tape Width(mm)	Quantity per Reel
D13AP2WF-7	Commercial	P2L	7	8	3,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information


P2L = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: G = 2019)
 M = Month (ex: 9 = September)
 Bar Denotes Cathode Side

Date Code Key

Year	2018	2019	2020	2021	2022	2023	2024
Code	F	G	H	I	J	K	L

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Pulse Power Dissipation (Note 5) 10/1000µs 8/20µs	P _{PK}	225 1125	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 6)	I _{FSM}	35	A

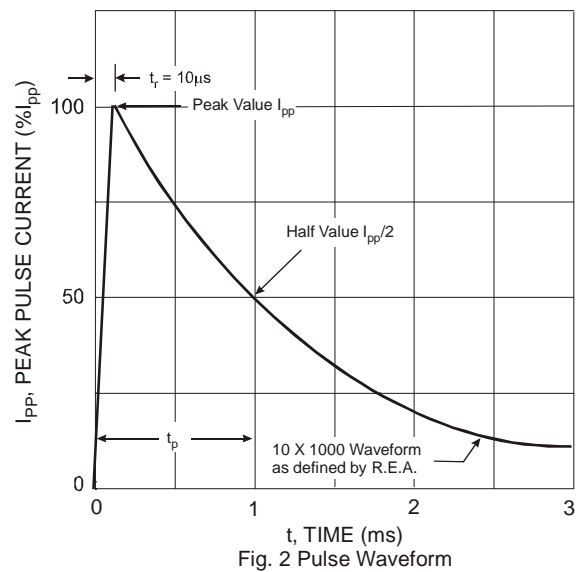
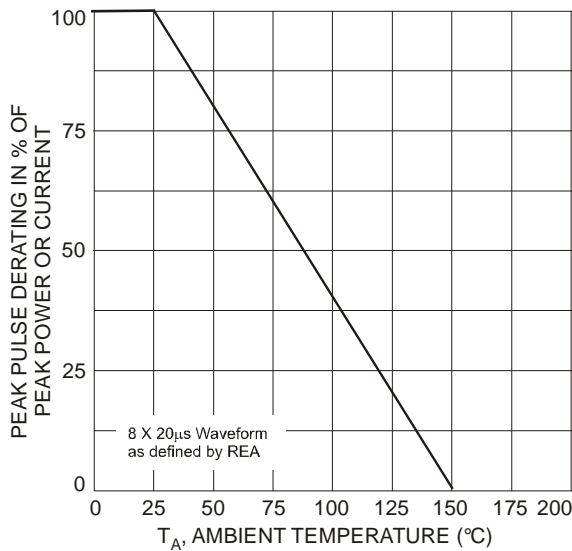
Thermal Characteristics

Characteristic	Symbol	Value	Unit
DC Steady-State Power Dissipation (Note 7)	P _D	1.0	W
Thermal Resistance, Junction to Ambient (Note 7)	R _{θJA}	330	°C/W
Thermal Resistance, Junction to Soldering Point (Note 8)	R _{θJS}	70	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Part Number	Reverse Standoff Voltage	Breakdown Voltage V _{BR} @ I _T (Note 9)		Test Current	Max. Reverse Leakage @ V _{RWM}	Max. Clamping Voltage @ I _{PP}	Max. Peak Pulse Current I _{PP} (Note 5)	Marking Code
	V _{RWM} (V)	Min (V)	Max (V)	I _T (mA)	I _R (µA)	V _C (V)	(A)	
D13AP2WF	13	14.4	15.9	1	1	21.5	10.5	P2L

- Notes:
5. Non-Repetitive current pulse as shown in Figure 2.
 6. 1/2 sine wave (or equivalent square wave), pulse width = 8.3ms, duty cycle = 4 pulses/minute maximum.
 7. Device mounted on 1" x 1", FR-4 PCB; 2 oz. Cu pad layout.
 8. Theoretical R_{θJS} calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
 9. V_{BR} measured at pulse test current I_T with t_p ≤ 5.0ms at T_A = +25°C.



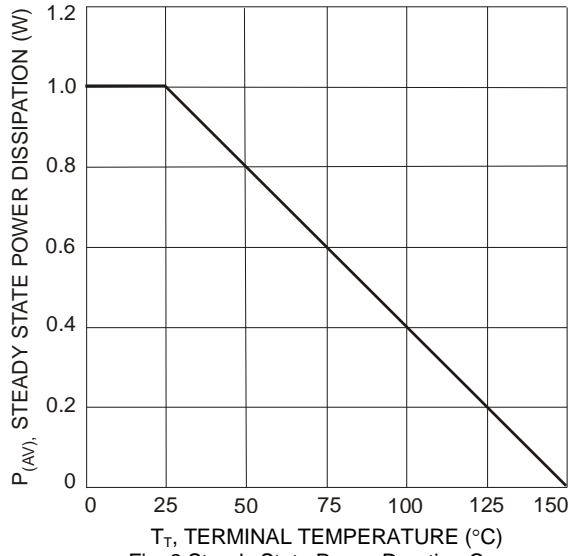


Fig. 3 Steady State Power Derating Curve

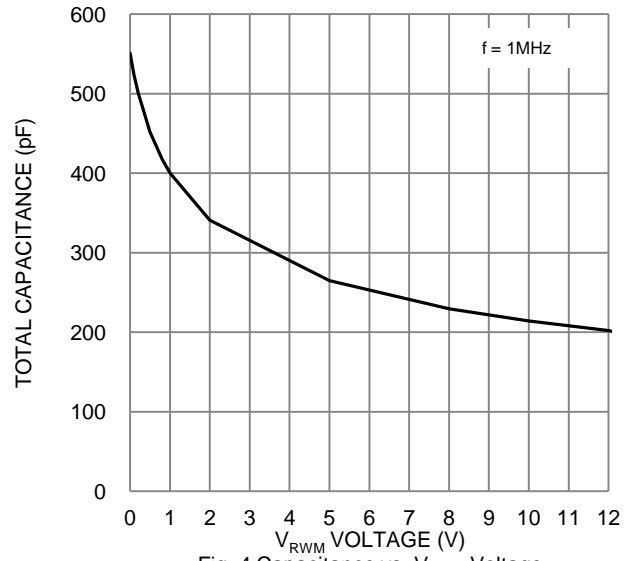
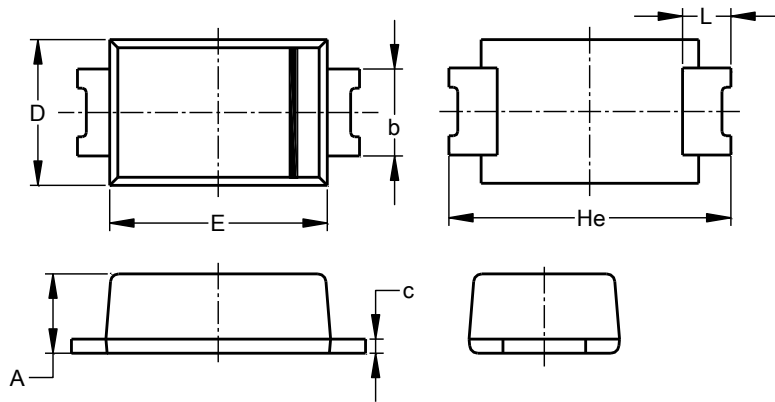


Fig. 4 Capacitance vs. V_{RWM} Voltage

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F (Type B)

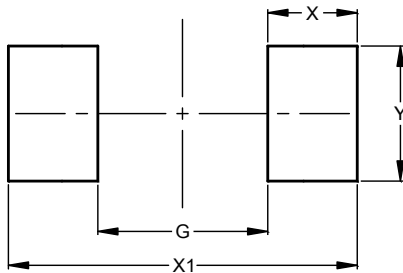


SOD123F (Type B)			
Dim	Min	Max	Typ
A	0.81	1.15	—
b	0.80	1.35	—
c	0.05	0.30	—
D	1.70	1.90	1.80
E	2.60	2.80	2.70
He	3.30	3.70	3.50
L	0.35	0.85	—
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F (Type B)



Dimensions	Value (in mm)
G	1.90
X	1.00
X1	3.90
Y	1.50

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2019, Diodes Incorporated

www.diodes.com

单击下面可查看定价，库存，交付和生命周期等信息

[>>Diodes Incorporated\(达达科技\(美台\)\)](#)